



## News Release

### **Unisem Reports Revenue of RM280.1 million (approx. US\$78.1 million) and Net Profit of RM23.9 million (approx. US\$6.7 million) for First Quarter 2015**

**Kuala Lumpur, 28 April 2015** – Unisem (M) Berhad today announced results for the first quarter ended 31 March 2015 (**1Q15**).

Unisem recorded a consolidated revenue of RM280.1 million (approx. US\$78.1 million) for 1Q15, which represents 1.9 percent decline from the preceding quarter (**4Q14**) and increase of 22.8 percent compared to revenue recorded in the same quarter a year ago (**1Q14**). The Group recorded a consolidated net profit of RM23.9 million (approx. US\$6.7 million), an increase of 12.2 percent compared to net profit recorded in 4Q14 and net profit of RM8.8 million (approx. US\$2.7 million) in 1Q14.

The increase in revenue for the current quarter was mainly attributable to higher demand for the products and services of the Group. The improvement in net profit for the current quarter was primarily due to increased gross profit margin arising from change in product mix and improved utilization rates.

Group earnings before interest, tax, depreciation and amortization (**EBITDA**) for 1Q15 came in at about RM70.9 million (approx. US\$19.8 million), EBITDA margin was about 25.3 percent, compared to RM72.1 million (approx. US\$21.7 million), in 4Q14. Equipment capacity utilization averaged at about 73 percent for the Group in 1Q15. Group capital expenditure incurred in 1Q15 was about RM37.5 million (approx. US\$10.5 million), principally for purchase of equipment for advanced packaging activities.

Commenting on the outlook of the Group, Mr. John Chia Sin Tet, the group managing director said, "We expect the performance of the Group to continue to improve for the second quarter till the end of the financial year with increasing demand seen for our products and services in the smartphone and automotive market segments."

#### **About Unisem**

Unisem is a global provider of semiconductor assembly and test services for many of the world's most successful electronics companies. Unisem offers an integrated suite of packaging and test services such as wafer bumping, wafer probing, wafer grinding, a wide range of leadframe and substrate IC packaging, wafer level CSP and RF, analog, digital and mixed-signal test services. Our turnkey services include design, assembly, test, failure analysis, and electrical and thermal characterization. With approximately 6800 employees worldwide, Unisem has factory locations in Ipoh, Malaysia; Chengdu, People's Republic of China; Batam, Indonesia and Sunnyvale, USA. The company is headquartered in Kuala Lumpur, Malaysia. For more information about the company, its products and services, please visit its website at [www.unisemgroup.com](http://www.unisemgroup.com)